

DECLARATION FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name. I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: OPTICAL PICK-UP, the specification of which

(X) is attached hereto.

() was filed on

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, 1.56(a).

Foreign Priority Applications

I hereby claim foreign priority benefits under Title 35, United States Code 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

2000-397357	Japan	27 December 2000	Yes(X) No()
2001-093765	Japan	28 March 2001	Yes(X) No()
2001-183771	Japan	18 June 2001	Yes(X) No()
(Number)	(Country)	(Day/Month/Year Filed)	(Priority Claimed)

Provisional Applications

I hereby claim the benefit under title 35, United States Code, § 119(e) of any United States provisional application(s) listed below:

(Application Number)

(Filing Date)

U.S. Priority Applications

I hereby claim the benefit under Title 35, United States Code, Section 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of the application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, Section 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, Section 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Applic. Serial No.)

(Filing Date)

(Status patented/pending/abandoned)

Power of Attorney

I hereby appoint the following attorneys to prosecute this application and transact all business in the Patent and Trademark Office connected therewith: John E. Lynch, Reg. No. 20,197; Peter F. Felfe, Reg. No. 20,297; Norman D. Hanson, Reg. No. 30,946; John A. Bauer, Reg. No. 32,554; James Zubok, Reg. No. 38,671; Mary Anne Schofield, Reg. No. 36,669; James R. Crawford, Reg. No. 39,155; and Andrew Im, Reg. No. 40,657 my attorneys with full power of substitution and revocation. Address all telephone calls to James R. Crawford, 212-318-3148. Address all correspondence to:

FULBRIGHT & JAWORSKI, L.L.P.
666 Fifth Avenue
New York, NY 10103

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

(1) Kazuo HIROSE Kazuo Hirose 11.15.2001
Full Name/Sole or First Inventor Signature Date

Residence: c/o NTN Engineering Plastics Corporation
970 Oaza Anoh, Tohin-cho, Inabe-gun,
Mie 511-0243, Japan

Japan
Citizenship

Post Office Address: same as above

(2) Takumi HAYASHI Takumi Hayashi 11.15.2001
Full Name/Sole or First Inventor Signature Date

Residence: c/o NTN Engineering Plastics Corporation
970 Oaza Anoh, Tohin-cho, Inabe-gun,
Mie 511-0243, Japan

Japan
Citizenship

Post Office Address: same as above

(3) Kiyoshi ISHII Kiyoshi Ishii 11.27.2001
Full Name/Sole or First Inventor Signature Date

Residence: c/o Mold Research Institute Co., Ltd.
7-48-3, Nishikamata, Ota-ku,
Tokyo 144-0051, Japan

Japan
Citizenship

Post Office Address: same as above
